

## Differential Pairs

Conductor Width (W)

**3.1** mils

Target Zdiff

**100** Ohms

Formula Restrictions:

 $0.1 < W/H < 3.0$  $0.1 < S/H < 3.0$ 

Conductor Spacing (S)

**4** mils

Conductor Height (H1)

**4** mils

Conductor Height (H2)

**3.9** mils**W/H = 0.360****S/H = 0.465**

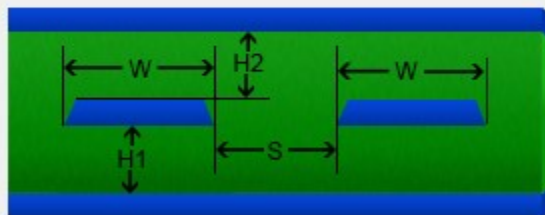
Zdifferential

**100.501 Ohms**

Zo

**55.653 Ohms**

+/- Tolerance = 10%

**110.551 Ohms****90.451 Ohms**

## Options

## Base Copper Weight

- ☐ 0.25oz  
☒ 0.5oz  
☐ 1oz  
☐ 1.5oz  
☐ 2oz  
☐ 2.5oz  
☐ 3oz  
☐ 4oz  
☐ 5oz

## Plating Thickness

- ☐ Bare PCB  
☐ 0.5oz  
☒ 1oz  
☐ 1.5oz  
☐ 2oz  
☐ 2.5oz  
☐ 3oz

## Differential Layer

- ☐ Edge CpId Ext  
☐ Edge CpId Int Sym  
☒ Edge CpId Int Asym  
☐ Edge CpId Embed  
☐ Broad CpId Shld  
☐ Broad CpId NShld

## Units

- ☒ Imperial  
☐ Metric

## Substrate Options

Material Selection

Er

Tg (°C)

**3.86****130**

Temp Rise (°C)

**20**

Temp in (°F) = 36.0

Ambient Temp (°C)

**22**

Temp in (°F) = 71.6

Print

Solve!

## Information

Total Copper Thickness  
0.70 milsVia Thermal Resistance  
N/AVia Count: **10**

Conductor Temperature

N/A

Temp in (°C) = N/A

Via Voltage Drop

Temp in (°F) = N/A

N/A